

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4997093

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the RECEIVING PARTY DATA (ASSIGNEE) previously recorded on Reel 039341 Frame 0605. Assignor(s) hereby confirms the "E. I. DU PONT DE NEMOURS AND COMPANY...19805" SHOULD BE "EKC TECHNOLOGY 2520 BARRINGTON COURT HAYWARD, CALIFORNIA 94545".

CONVEYING PARTY DATA

Name	Execution Date
HUA CUI	08/01/2016

RECEIVING PARTY DATA

Name:	EKC TECHNOLOGY INC
Street Address:	2520 BARRINGTON COURT
City:	HAYWARD
State/Country:	CALIFORNIA
Postal Code:	94545

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15028501

CORRESPONDENCE DATA

Fax Number: (302)355-4243

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 3029994278

Email: pto-legal.prc@dupont.com

Correspondent Name: E. I. DU PONT DE NEMOURS AND COMPANY

Address Line 1: 974 CENTRE ROAD

Address Line 2: CHESTNUT RUN PLAZA 721/2340

Address Line 4: WILMINGTON, DELAWARE 19805

ATTORNEY DOCKET NUMBER:	EK0399-US-PCT
NAME OF SUBMITTER:	AHNALESE RUSHMANN
SIGNATURE:	/Ahnalese Rushmann/
DATE SIGNED:	06/07/2018

Total Attachments: 3

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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
HUA CUI		08/01/2016
RECEIVING PARTY DATA		
Name:	E. I. DU PONT DE NEMOURS AND COMPANY	EKC TECHNOLOGY INC
Street Address:	CHESTNUT RUN PLAZA	2520 BARRINGTON COURT
Internal Address:	974 CENTRE ROAD, P.O. BOX 2915	
City:	WILMINGTON	HAYWARD
State/Country:	DELAWARE	CALIFORNIA
Postal Code:	19805	94545
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15028501	

PATENT

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Phone: 3029994278
Email: pto-legal.prc@dupont.com
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Correspondent Name: E. I. DU PONT DE NEMOURS AND COMPANY
Address Line 1: 974 CENTRE ROAD
Address Line 2: CHESTNUT RUN PLAZA 721/2340
Address Line 4: WILMINGTON, DELAWARE 19805

ATTORNEY DOCKET NUMBER:	EK0399-US-PCT
NAME OF SUBMITTER:	AHNALESE RUSHMANN
Signature:	/Ahnalese Rushmann/
Date:	08/04/2016
Total Attachments: 1 source=20160804_EK0399USPCT_AssignmentSigned#page1.tif	
RECEIPT INFORMATION	
EPAS ID:	PAT3992482
Receipt Date:	08/04/2016

RECEIPT INFORMATION

EPAS ID: PAT3992482
Receipt Date: 08/04/2016

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PATENT

NON-PROVISIONAL APPLICATION ASSIGNMENT

I, the undersigned

HUA CUI

Hereby declare that

I am the inventor of an invention entitled

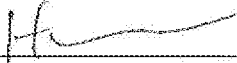
METHOD AND COMPOSITION FOR SELECTIVELY REMOVING METAL HARDMASK AND OTHER RESIDUES FROM SEMICONDUCTOR DEVICE SUBSTRATES COMPRISING LOW-K DIELECTRIC MATERIAL AND COPPER

which is disclosed in the United States Patent Application No. 15/028501 filed on October 09, 2014 and which is identified as Case Number EK0399-US-PCT.

For valuable consideration, the receipt and adequacy of which is hereby acknowledged and in fulfillment of our pre-existing obligation of assignment, I hereby:

I. Sell, assign, and transfer unto EKC TECHNOLOGY INC a corporation organized and existing under the laws of the State of California in the United States of America and having its principal place of business at Hayward, California, hereinafter referred to as the assignee, (A) the entire right, title, and interest in and to: (1) the aforesaid application for Letters Patent, (2) any priority rights derived from the aforesaid application for Letters Patent by virtue of the International Convention for the Protection of Industrial Property and any other treaty or understanding for intellectual property for any and all member countries of the aforesaid International Convention or other treaty or understanding, (3) any and all our inventions, whether joint or sole, disclosed in the aforesaid application for Letters Patent, (4) any and all applications for Letters Patent for any such inventions in any country whatsoever, (5) any and all patents for any such inventions in any country whatsoever; and (B) the sole right to (1) file such applications in its name or ours, (2) file such applications under the aforesaid International Convention or other treaty or understanding, (3) have said patents granted in its name or ours, and (4) enforce said patents and to sue for and recover profits and damages for any and all infringements thereof whether past or future; and

II. Agree, whenever requested, to communicate to said assignee, its successors, assigns, and legal representatives, any facts known to us respecting said inventions or the rights described above, to testify in any legal proceeding respecting said inventions or the rights described above, the location of that testimony to be in the country in which we reside or in the nearest country in which such testimony is legal should our country of residence prohibit such testimony, to execute all applications, papers or instruments necessary or required by said assignee, its successors, assigns and legal representatives, to carry into effect any of the provisions of this instrument, and generally to do everything possible to aid said assignee, its successors, assigns, and legal representatives to obtain and enforce proper patent protection for said inventions.



HUA CUI (L.S.)
DATE: 8/1/2016